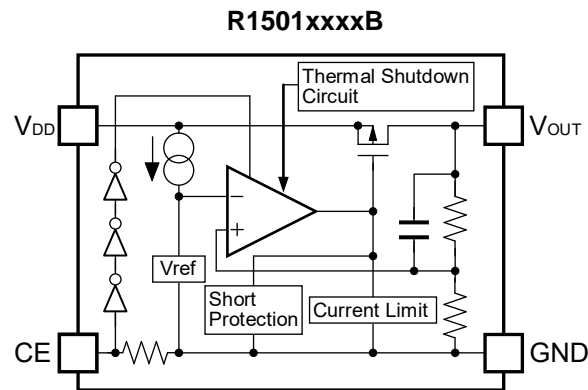

R1501x

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BLOCK DIAGRAMS**SELECTION GUIDE**

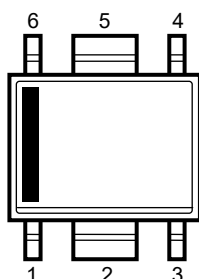
The output voltage, package, etc. for the ICs can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1501SxxxB-E2-FE	HSOP-6J	1,000 pcs	Yes	Yes
R1501JxxxB-T1-FE	TO-252-5-P2	3,000 pcs	Yes	Yes

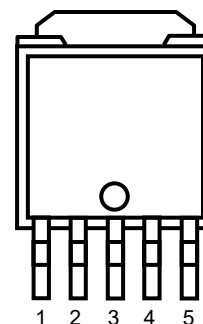
xxx : The output voltage can be designated in the range from 3.0V(030) to 12.0V(120) in 0.1V steps and 12.5V(125) to 18.0V(180) in 0.5V steps.
(For other voltages, please refer to MARK INFORMATION.)

PIN CONFIGURATIONS

• HSOP-6J



• TO-252-5-P2



PIN DESCRIPTIONS

• HSOP-6J

Pin No	Symbol	Pin Description
1	V_{DD}	Input Pin
2	GND*	Ground Pin
3	GND*	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	GND*	Ground Pin
6	V_{OUT}	Output Pin

*) No.2, No.3 and No.5 pins must be wired short each other and connected to the GND plane when it is mounted on board.

• TO-252-5-P2

Pin No	Symbol	Pin Description
1	V_{DD}	Input Pin
2	GND*	Ground Pin
3	GND*	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	V_{OUT}	Output Pin

*) No.2 and No.3 pins must be wired short each other and connected to the GND plane when it is mounted on board.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	-0.3 to 36	V
V_{CE}	Input Voltage (CE Pin)	-0.3 to $V_{IN} + 0.3 \leq 36$	V
V_{OUT}	Output Voltage	-0.3 to $V_{IN} + 0.3 \leq 36$	V
P_D	Power Dissipation (HSOP-6J)*	1700	mW
	Power Dissipation (TO-252-5-P2)*	1900	
T_{opt}	Operating Temperature Range	-40 to 105	°C
T_j	Operating Junction Temperature Range	-40 to 125	°C
T_{stg}	Storage Temperature Range	-55 to 125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.

The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

• R1501xxxxB

$V_{IN}=V_{SET}+1.0V$, $V_{CE}=V_{IN}$, unless otherwise noted.

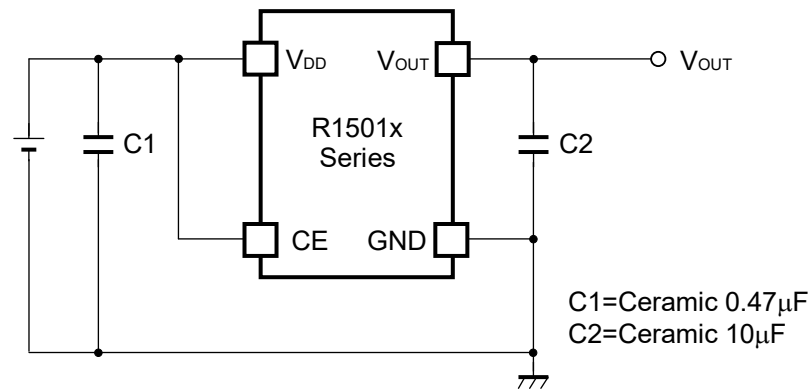
The specification in is checked and guaranteed by design engineering at $-40^{\circ}C \leq T_{opt} \leq 105^{\circ}C$.

$T_{opt}=25^{\circ}C$

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
V_{IN}	Input Voltage			3		24	V
V_{OUT}	Output Voltage	$I_{OUT}=1mA$	$T_{opt}=25^{\circ}C$	$\times 0.98$		$\times 1.02$	V
			$-40^{\circ}C \leq T_{opt} \leq 105^{\circ}C$	$\times 0.965$		$\times 1.035$	V
I_{SS}	Supply Current	$V_{IN}=24V$, $I_{OUT}=0A$			70	160	μA
$I_{standby}$	Standby Current	$V_{IN}=24V$, $V_{CE}=0V$			0.1	1.0	μA
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	$0.1mA \leq I_{OUT} \leq 200mA$			25	60	mV
		$0.1mA \leq I_{OUT} \leq 1A$ *guaranteed by design engineering			125	300	mV
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$V_{SET}+1V \leq V_{IN} \leq 24V$, $I_{OUT}=10mA$			0.05	0.1	%/V
V_{DIF}	Dropout Voltage	$I_{OUT}=200mA$	$3.0V \leq V_{SET} < 5.0V$		0.135	0.225	V
			$5.0V \leq V_{SET} < 9.0V$		0.115	0.180	
			$9.0V \leq V_{SET} < 12.0V$		0.095	0.155	
			$12.0V \leq V_{SET} \leq 18.0V$		0.090	0.140	
		$I_{OUT}=1A$ *guaranteed by design engineering	$3.0V \leq V_{SET} < 5.0V$		0.675	1.125	V
			$5.0V \leq V_{SET} < 9.0V$		0.575	0.900	
			$9.0V \leq V_{SET} < 12.0V$		0.475	0.775	
			$12.0V \leq V_{SET} \leq 18.0V$		0.450	0.700	
$\Delta V_{OUT}/\Delta T_{opt}$	Output Voltage Temperature Coefficient	$I_{OUT}=1mA$ $-40^{\circ}C \leq T_{opt} \leq 105^{\circ}C$			± 100		ppm/ $^{\circ}C$
I_{LIM}	Output Current			1			A
I_{SC}	Short Current Limit	$V_{OUT}=0V$			65		mA
RR	Ripple Rejection	$f=1kHz$, Ripple 0.5Vp-p, $I_{OUT}=100mA$, $V_{IN}=V_{SET}+2V$	$V_{SET} \leq 6.0V$		60		dB
			$V_{SET} > 6.0V$		50		
V_{CEH}	CE Input Voltage "H"			2.0		V_{IN}	V
V_{CEL}	CE Input Voltage "L"			0		0.5	V
T_{TSD}	Thermal Shutdown Temperature	Junction Temperature			160		$^{\circ}C$
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature			135		$^{\circ}C$

All of unit are tested and specified under load conditions such that $T_{opt}=25^{\circ}C$ except for Output Voltage Temperature Coefficient, Ripple Rejection, Thermal Shutdown Temperature, Thermal Shutdown Released Temperature, Load Regulation at $0.1mA \leq I_{OUT} \leq 1A$, Dropout Voltage at $I_{OUT}=1A$.

TYPICAL APPLICATION



(External Components)

C2: Ceramic 10 μ F MURATA: GRM32DB31E106K (size: 3225)

TECHNICAL NOTES

When using these ICs, consider the following points:

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with good frequency characteristics and ESR (Equivalent Series Resistance).

If you use a tantalum type capacitor and ESR value of the capacitor is large, output might be unstable. Evaluate your circuit with considering frequency characteristics.

Depending on the capacitor size, manufacturer, and part number, the bias characteristics and temperature characteristics are different. Evaluate the circuit with actual using capacitors.

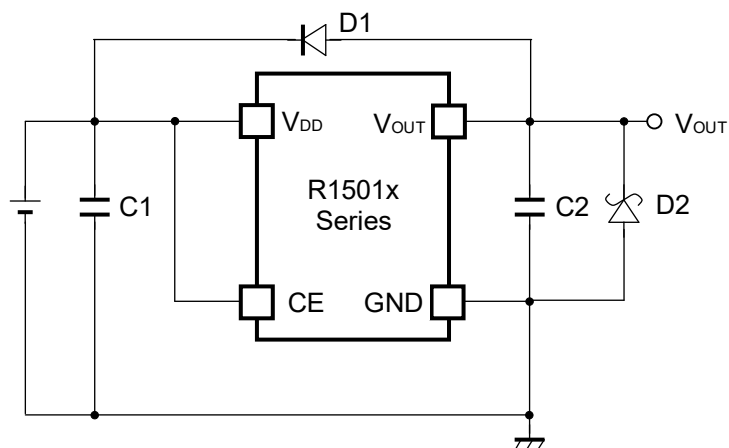
PCB Layout

Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as 0.47 μ F or more between V_{DD} and GND pin, and as close as possible to the pins.

Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

No.2 pin, No.3 pin and No.5 pin of HSOP-6J package must be wired to the GND plane when it is mounted on board. No.2 pin and No.3 pin of TO-252-5-P2 package must be wired to the GND plane when it is mounted on board.

TYPICAL APPLICATION FOR PREVENTING IC DESTRUCTION



C1: 0.47 μ F or more (preventing for unstable operation)

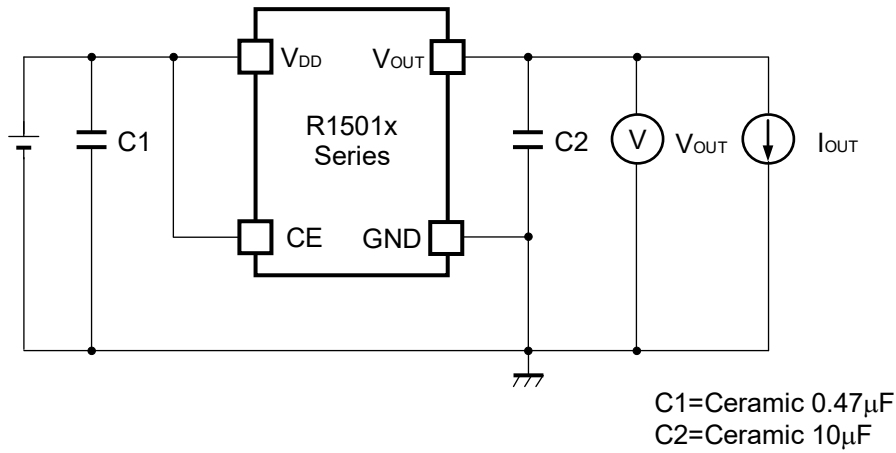
C2: 10 μ F or more (preventing for unstable operation)

D1: If V_{OUT} pin could be higher than V_{IN} pin, D1 is necessary.

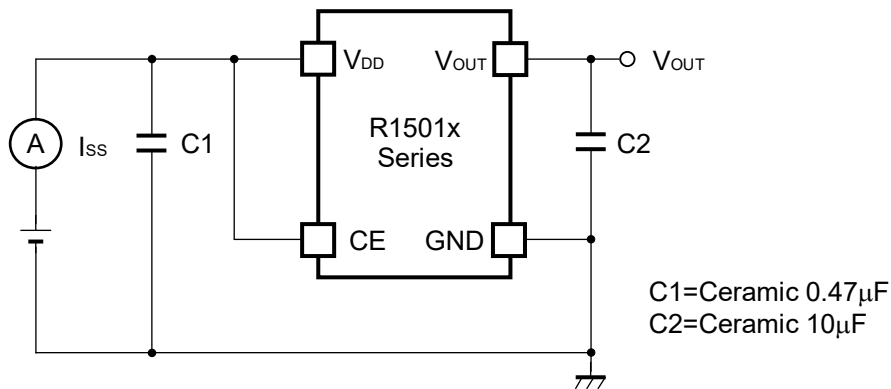
D2: If V_{OUT} pin could be lower than GND pin, SBD is necessary.

Note: Do not force the voltage to V_{OUT} pin.

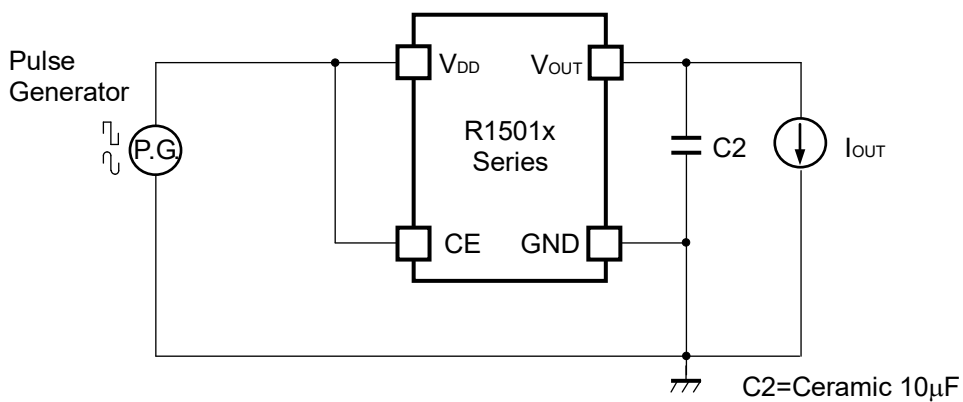
TEST CIRCUITS



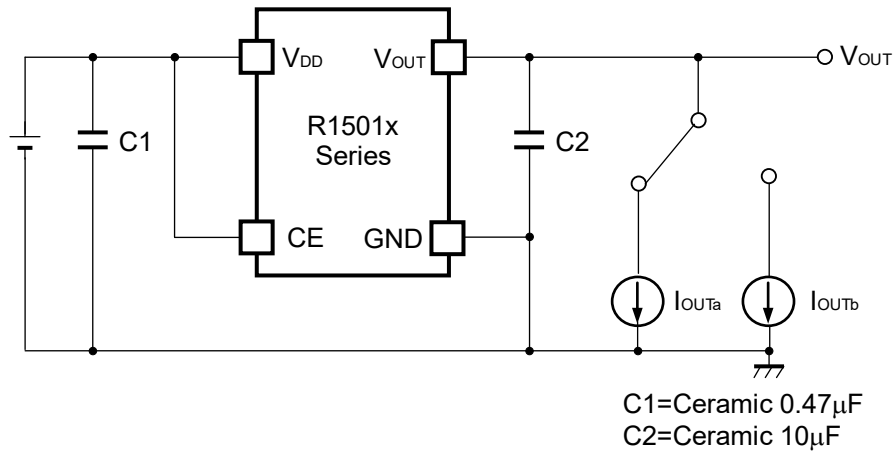
Basic Test Circuit



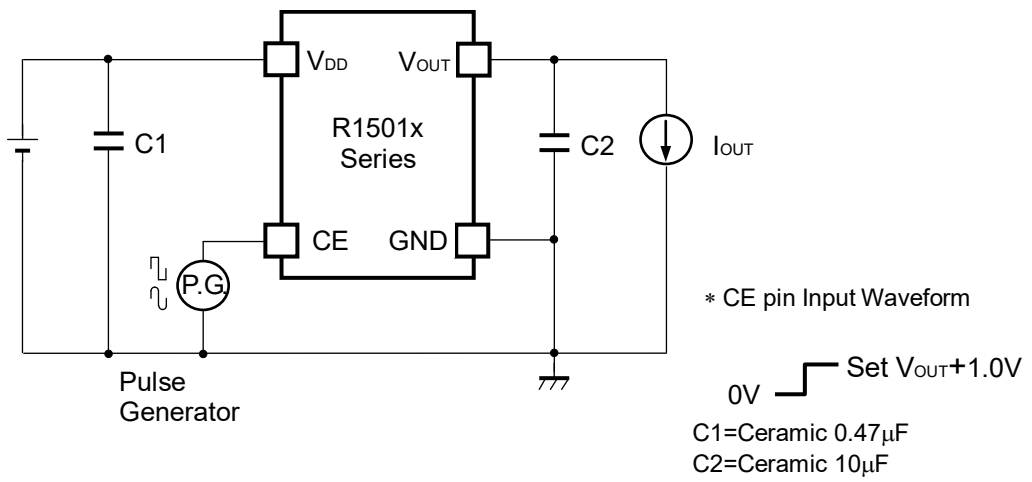
Test Circuit for Supply Current



Test Circuit for Ripple Rejection, Input Transient Response



Test Circuit for Load Transient Response

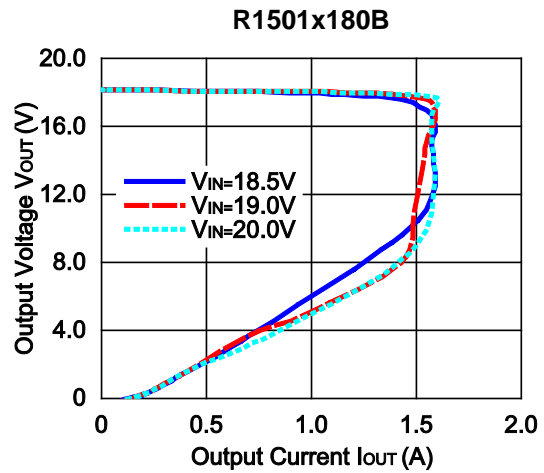
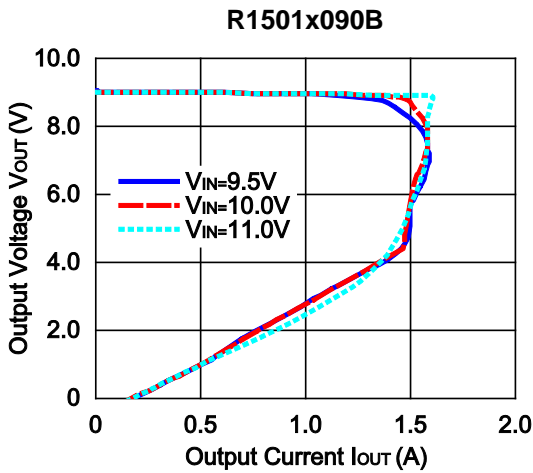
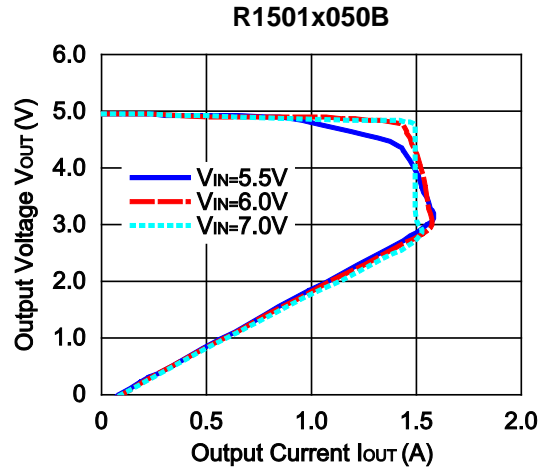
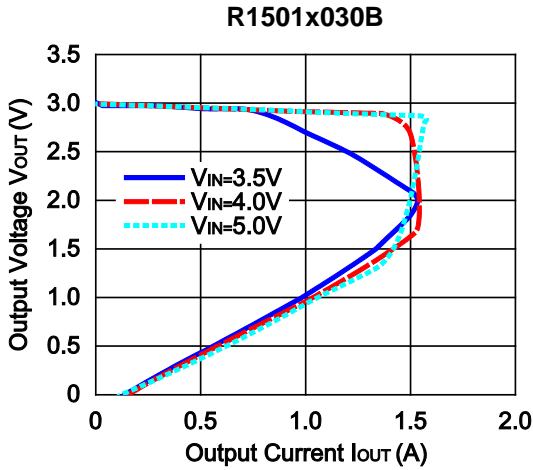


Test Circuit for Turn On Speed with CE pin

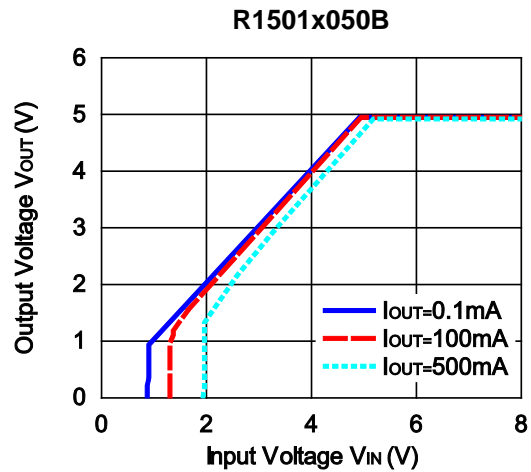
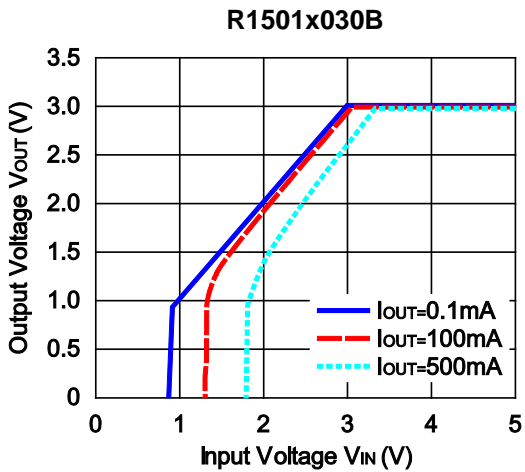
TYPICAL CHARACTERISTICS

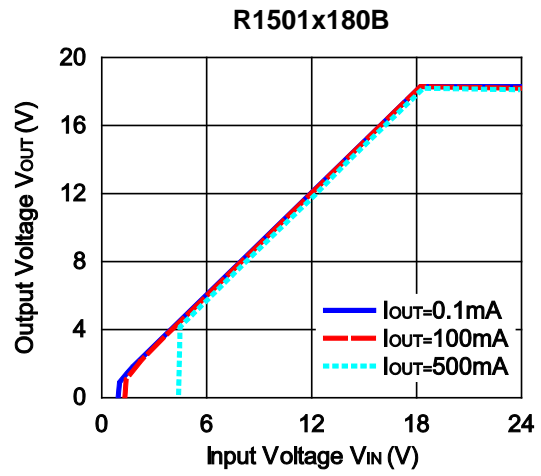
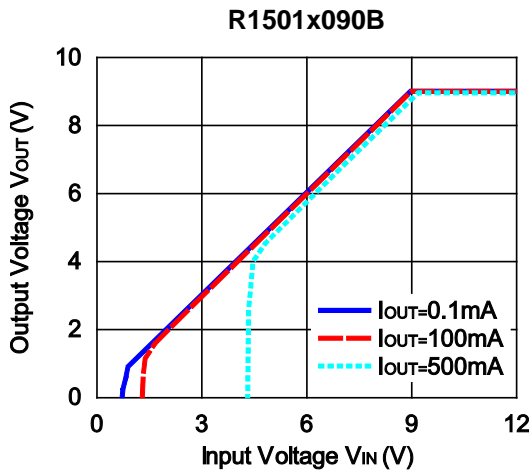
*T_{opt}=25°C, unless otherwise noted.

1) Output Voltage vs. Output Current (C1=Ceramic 0.47μF, C2=Ceramic 10μF)

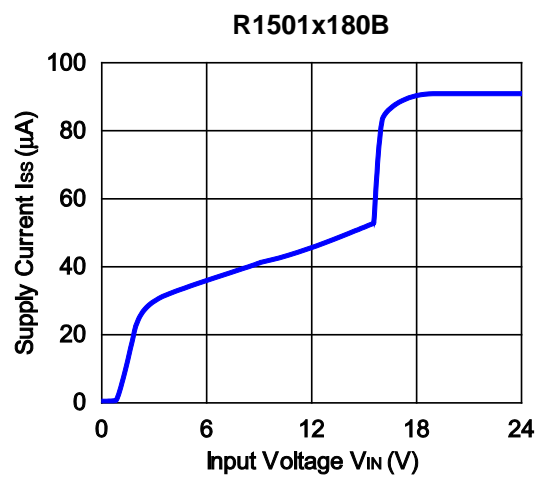
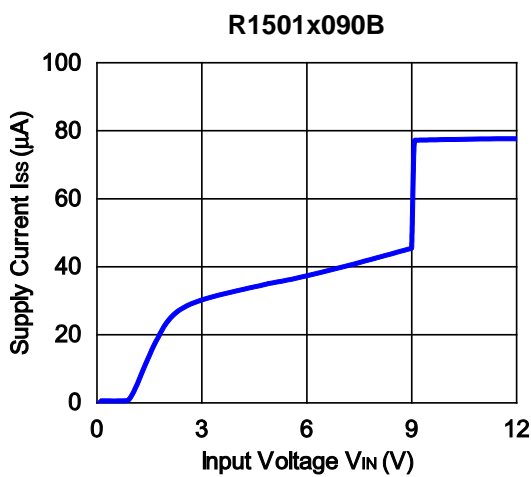
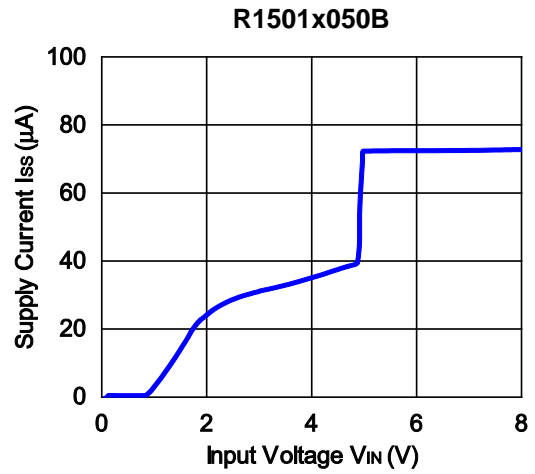
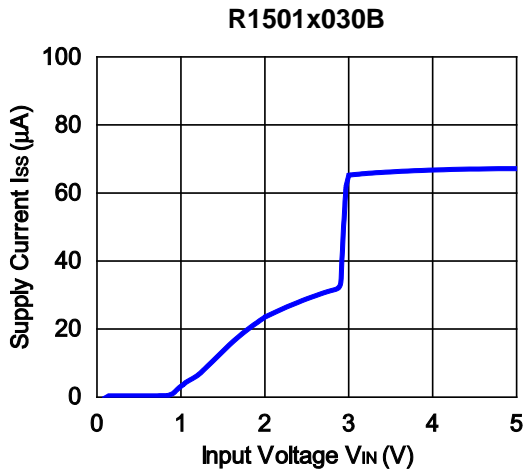


2) Output Voltage vs. Input Voltage (C1=Ceramic 0.47μF, C2=Ceramic 10μF)





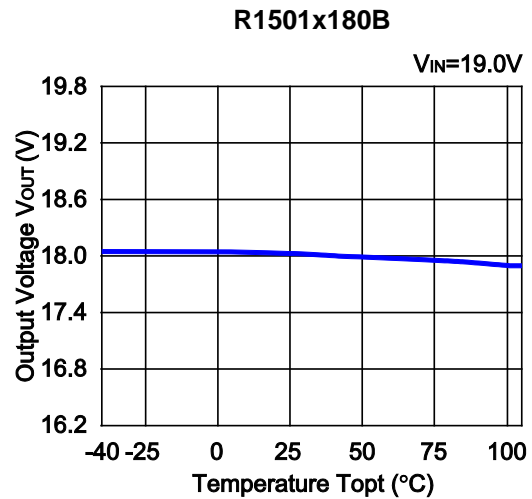
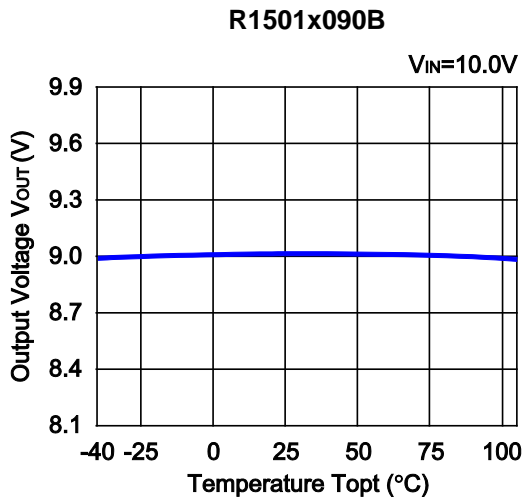
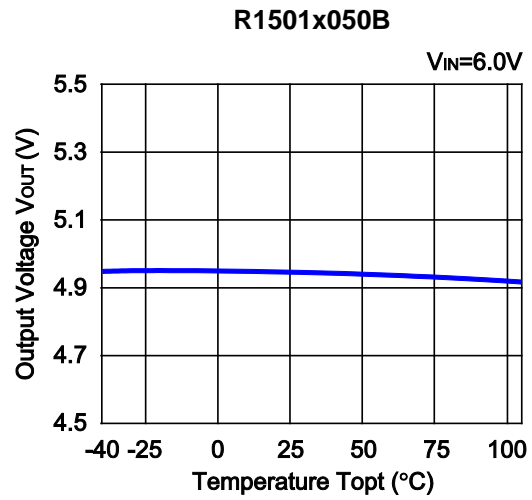
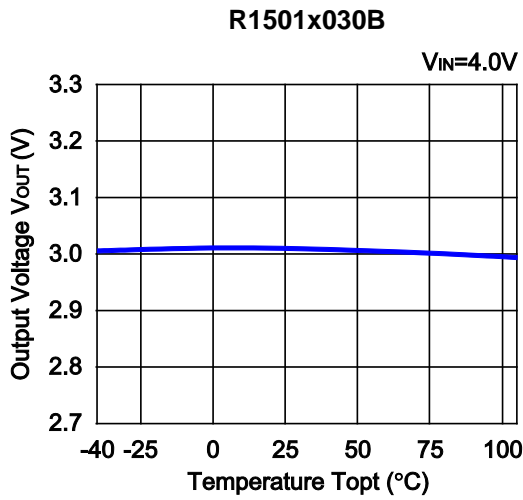
3) Supply Current vs. Input Voltage (C1=Ceramic 0.47 μ F, C2=Ceramic 10 μ F)



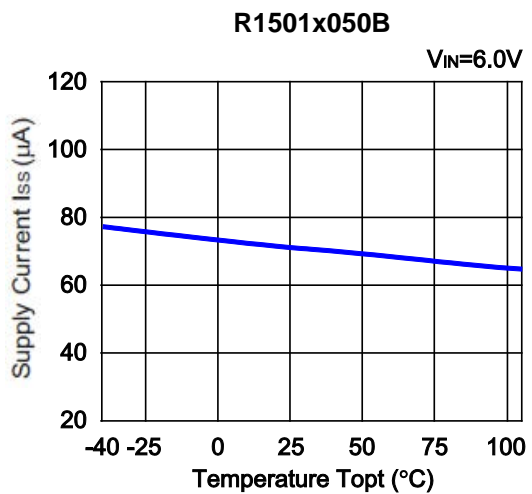
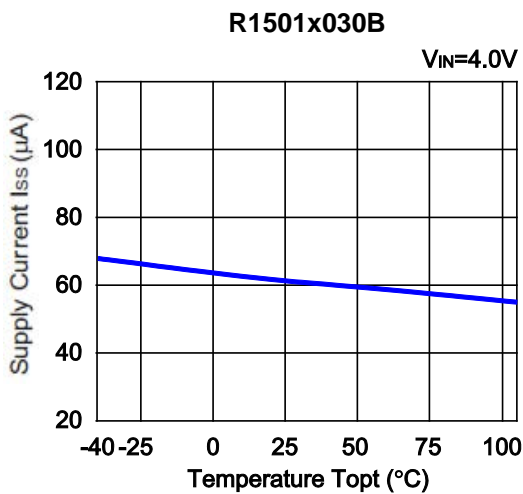
R1501x

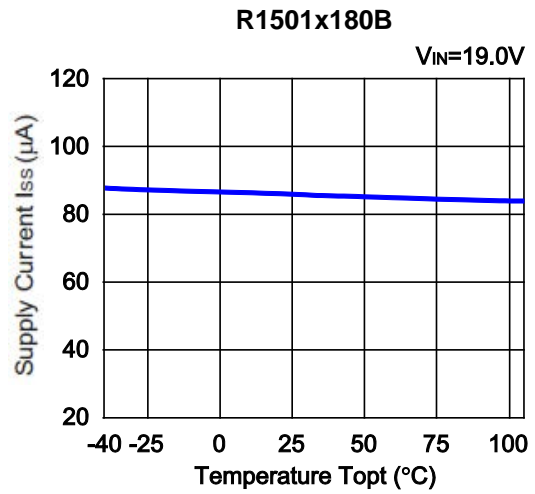
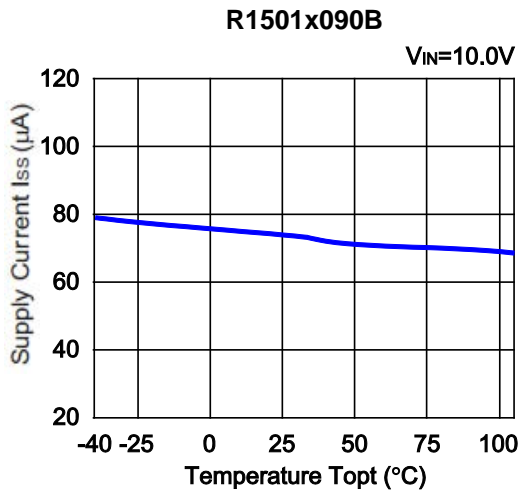
NO.EA-184-160801

4) Output Voltage vs. Temperature (C1=Ceramic 0.47 μ F, C2=Ceramic 10 μ F, I_{OUT}=1mA)

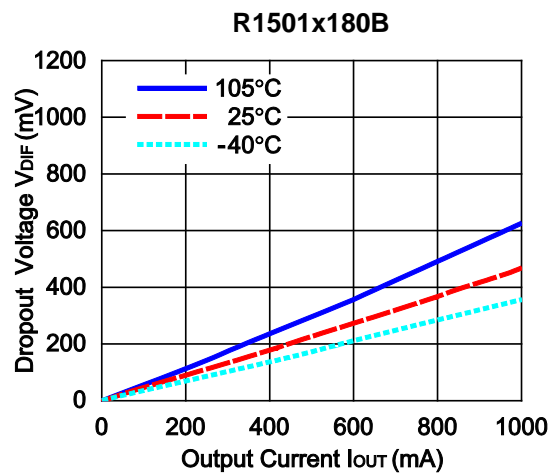
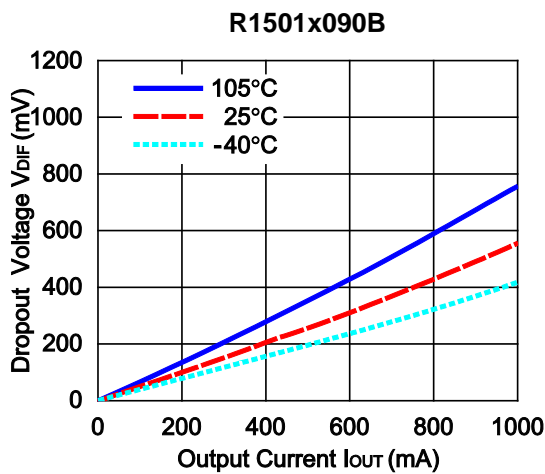
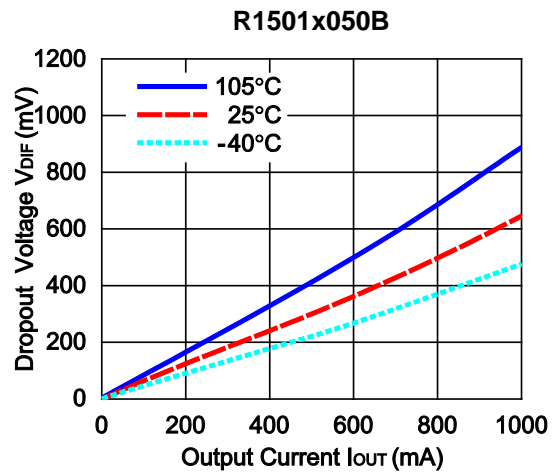
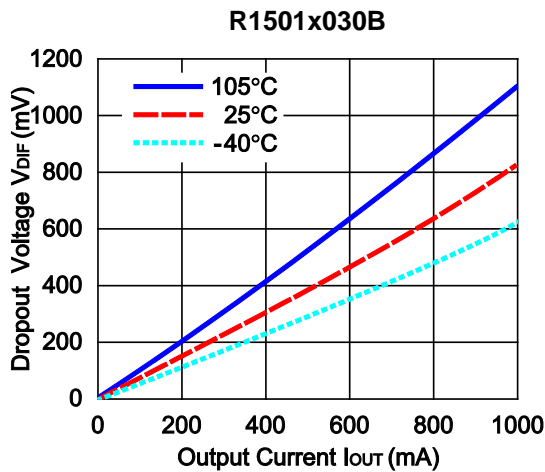


5) Supply Current vs. Temperature (C1=Ceramic 0.47 μ F, C2=Ceramic 10 μ F, I_{OUT}=0mA)





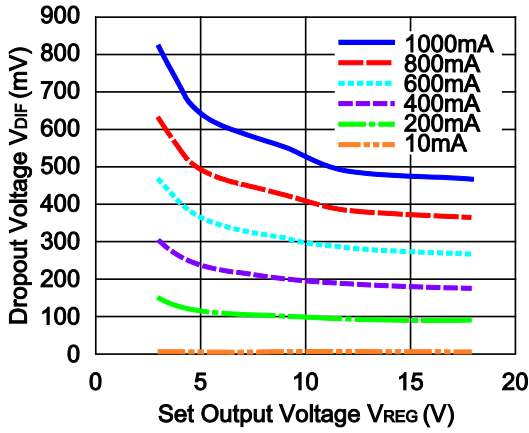
6) Dropout Voltage vs. Output Current (C1=Ceramic 0.47µF, C2=Ceramic 10µF)



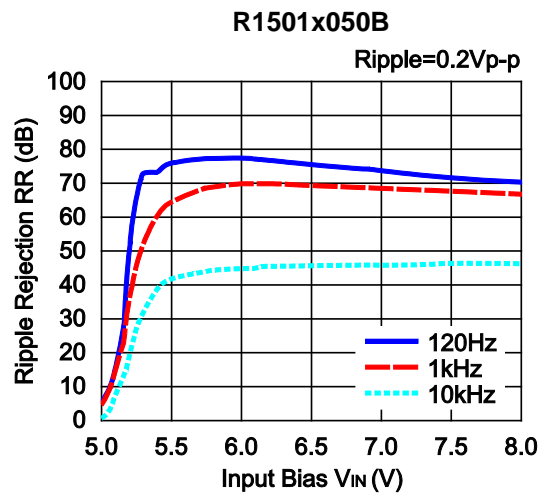
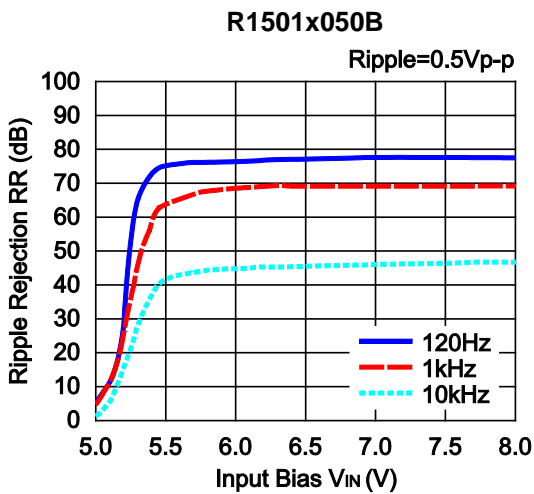
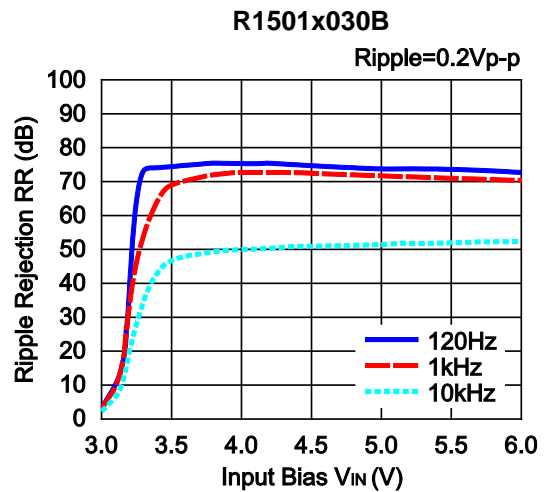
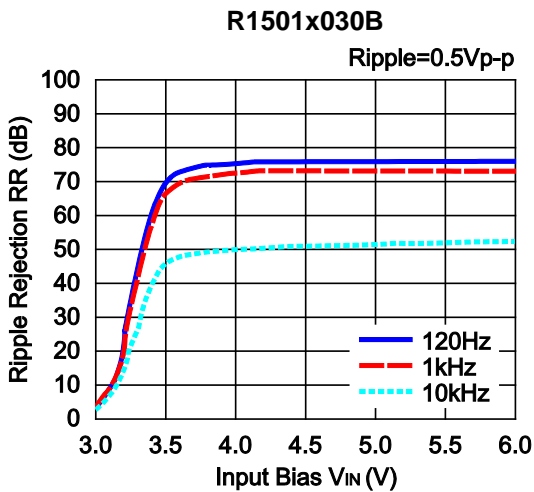
R1501x

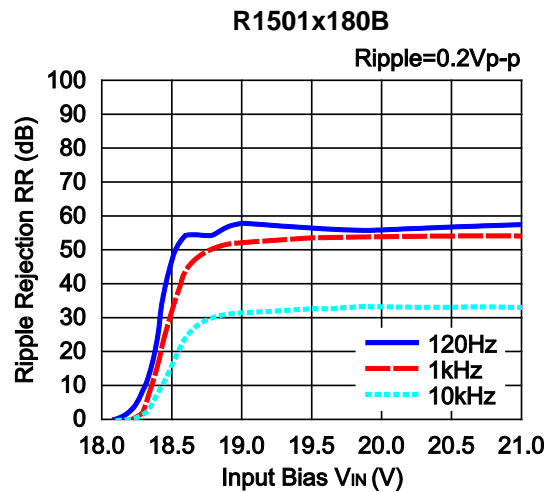
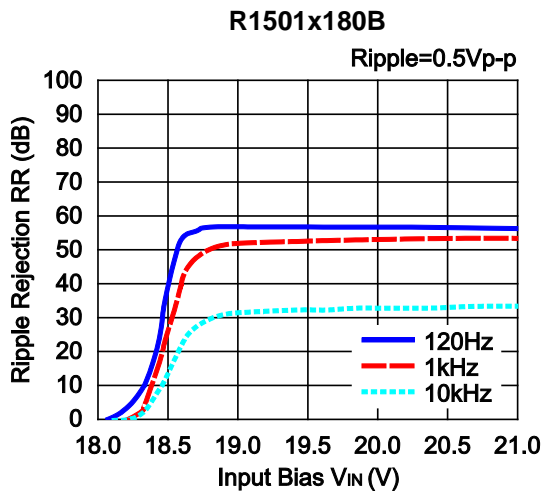
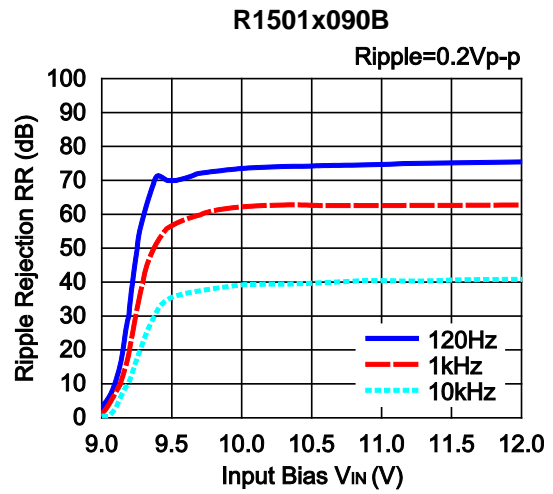
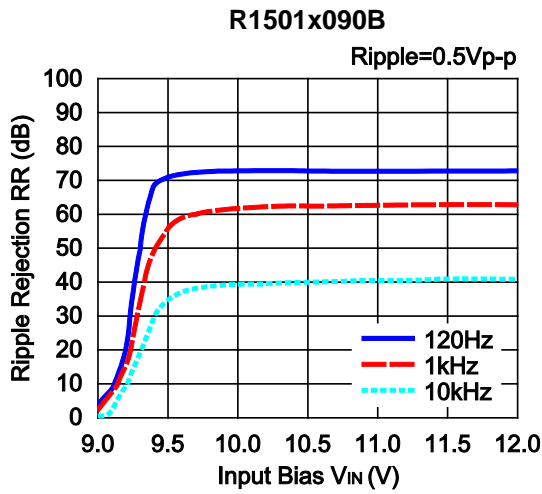
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7) Dropout Voltage vs. Set Output Voltage (C1=Ceramic 0.47 μ F, C2=Ceramic 10 μ F)

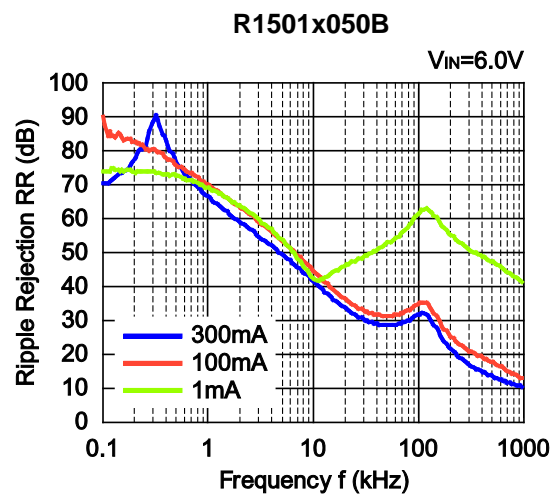
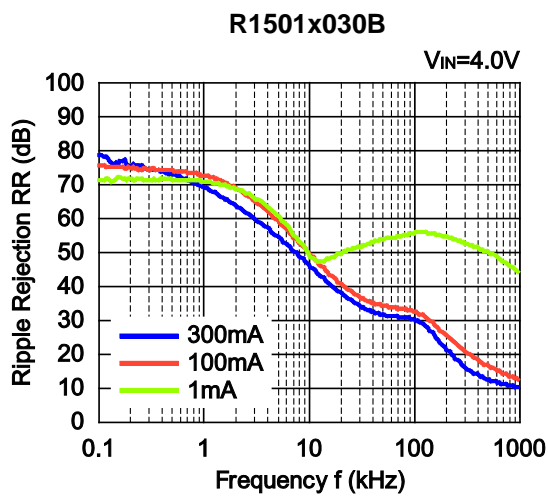


8) Ripple Rejection vs. Input Bias Voltage (C1=none, C2=Ceramic 10 μ F, I_{OUT} =100mA)



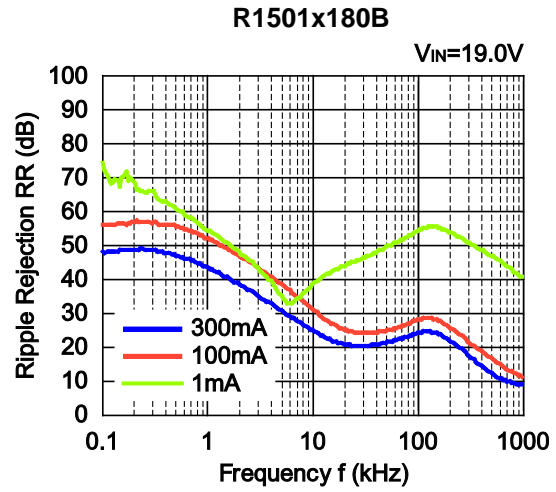
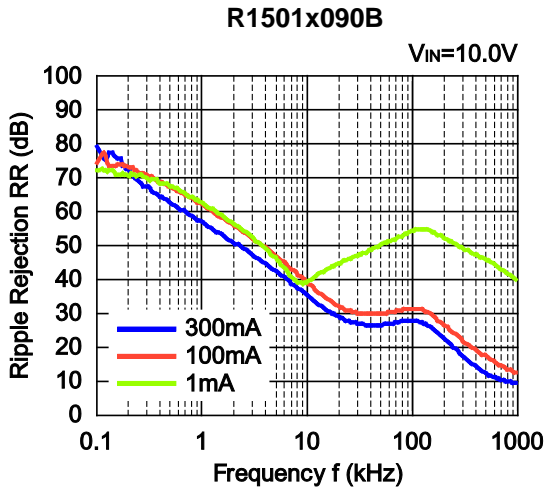


9) Ripple Rejection vs. Frequency (C1=none, C2=Ceramic 10μF, Ripple=0.5Vp-p)

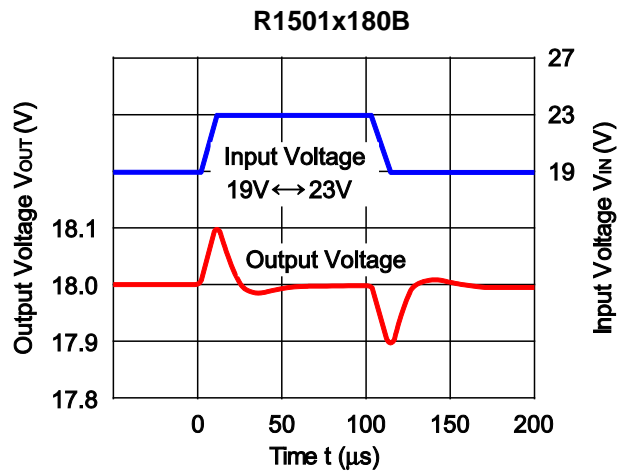
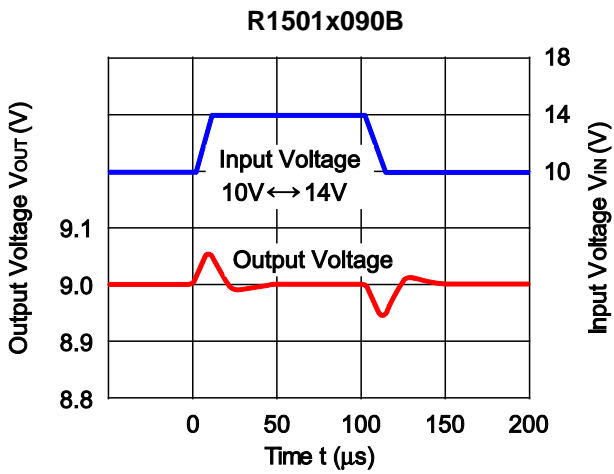
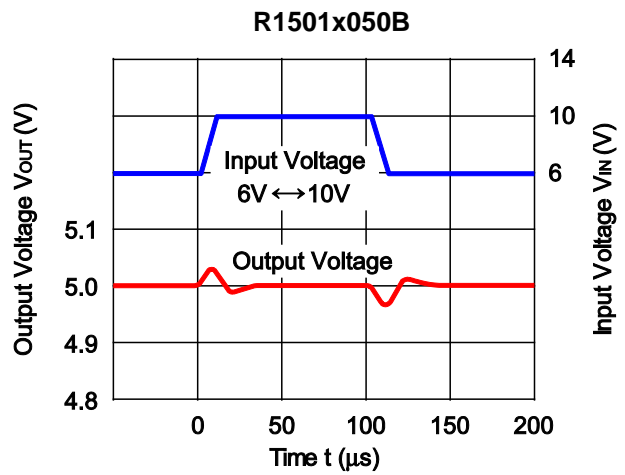
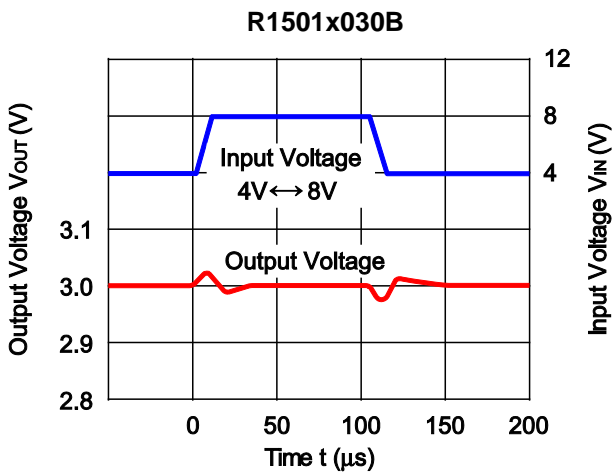


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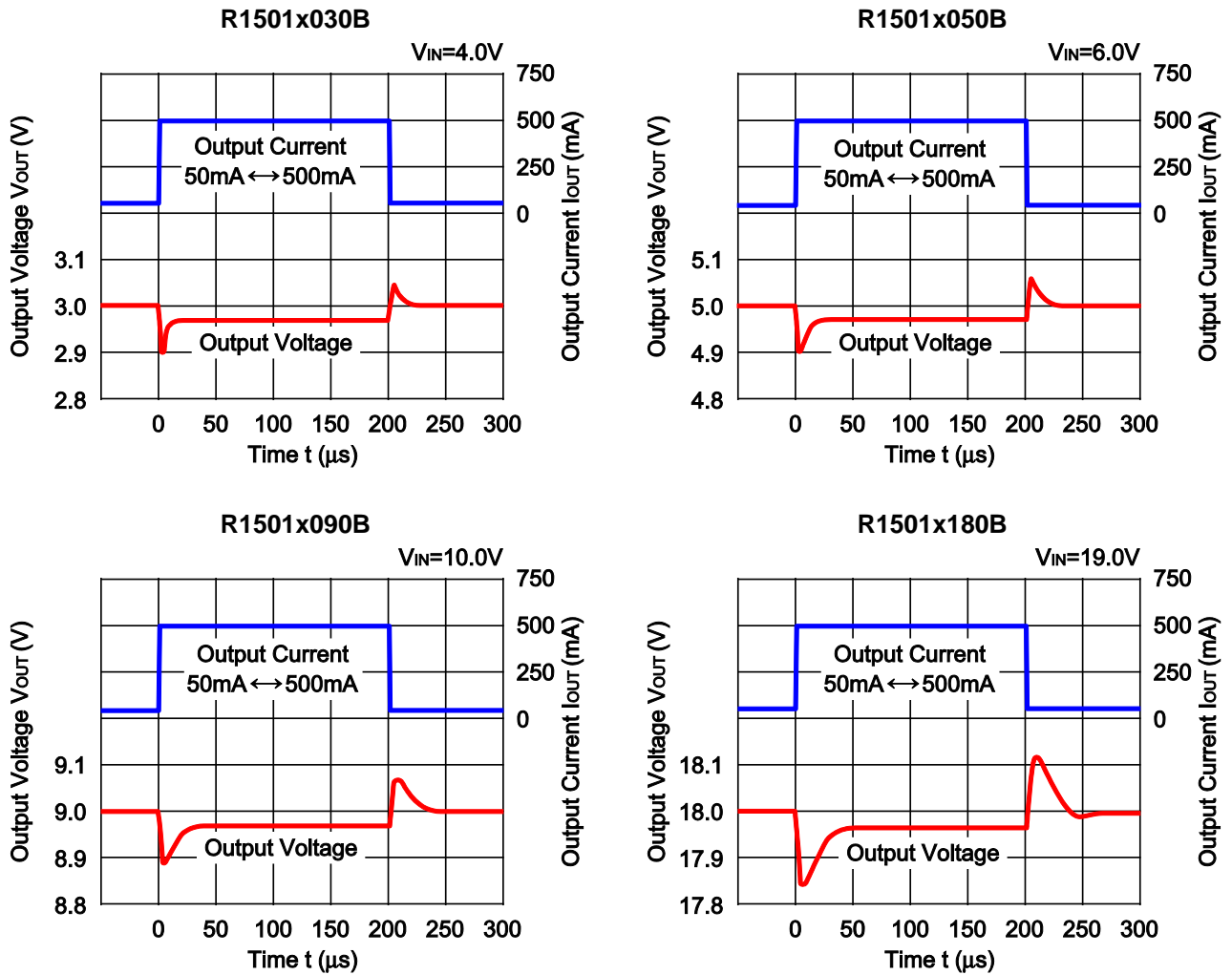
NO.EA-184-160801



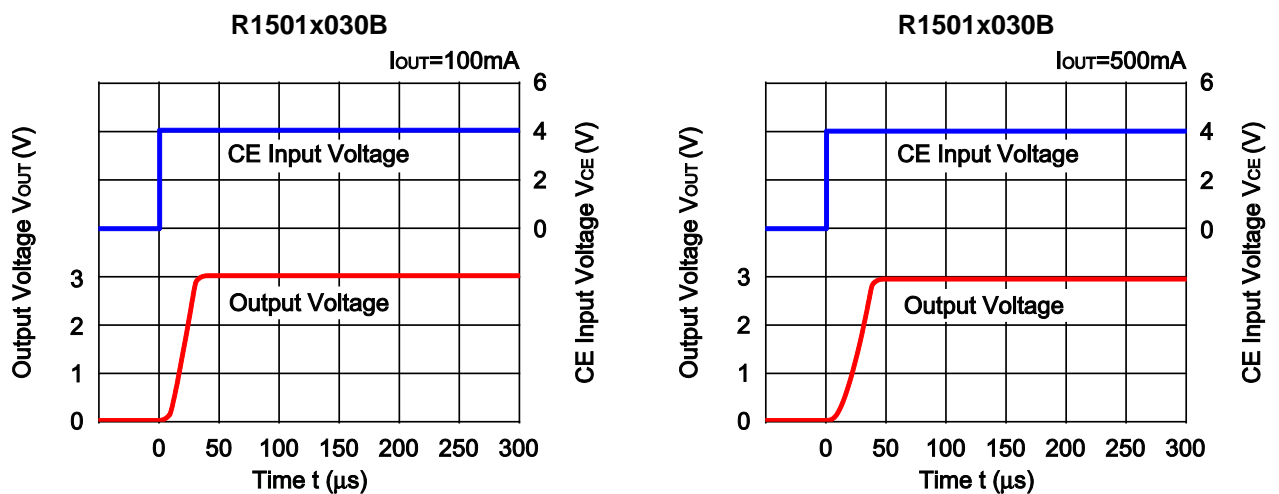
10) Input Transient Response (C1=none, C2=Ceramic 10 μ F, I_{OUT}=100mA, tr=tf=10 μ s)



11) Load Transient Response (C1=Ceramic 0.47μF, C2=Ceramic 10μF, tr=tf=0.5μs)

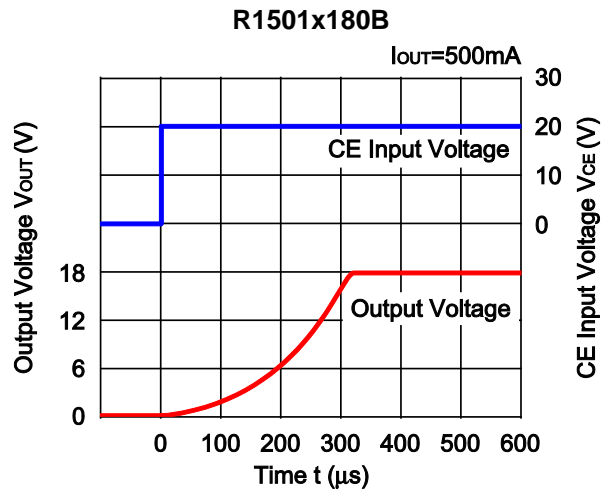
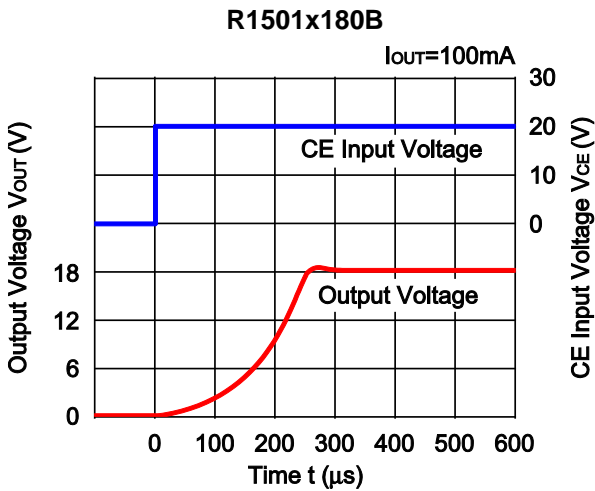
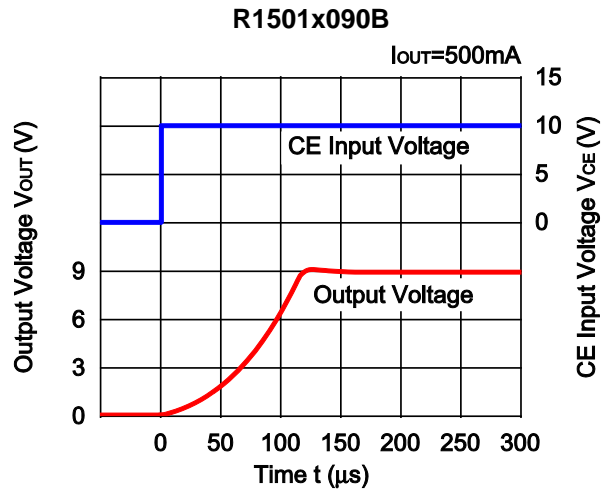
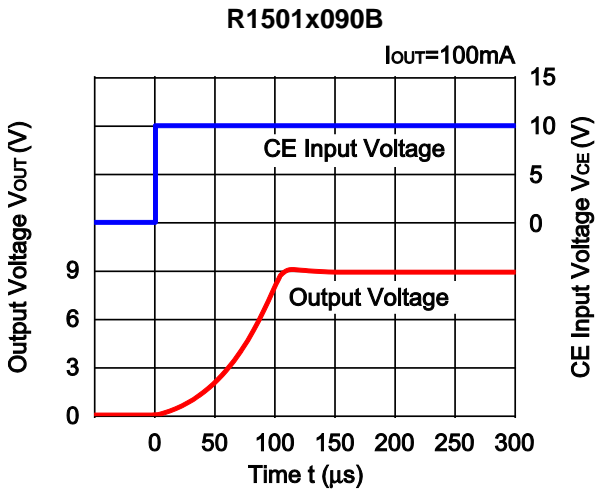
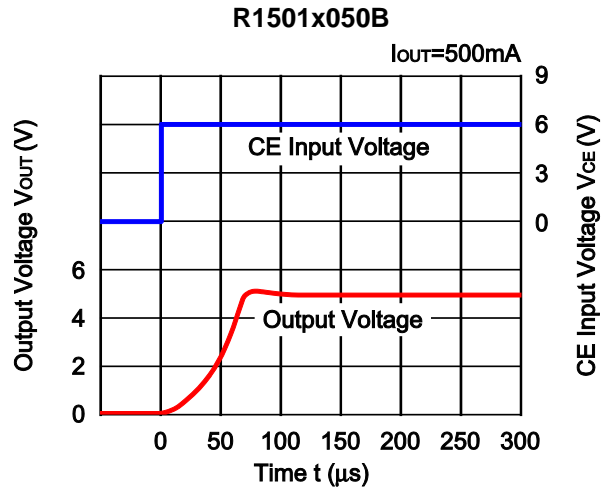
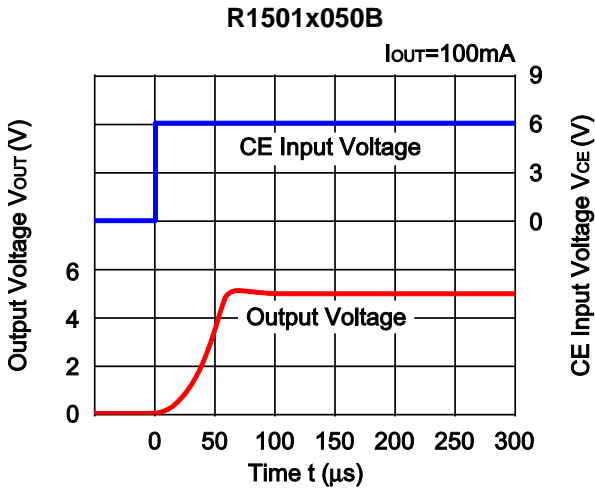


12) Turn On Speed with CE pin (C1=Ceramic 0.47μF, C2=Ceramic 10μF, tr=tf=0.5μs)

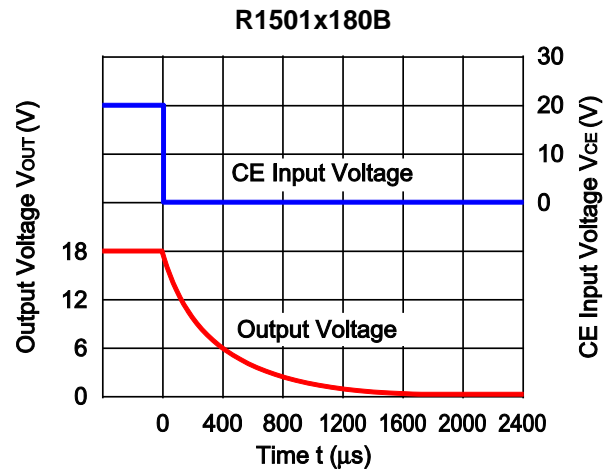
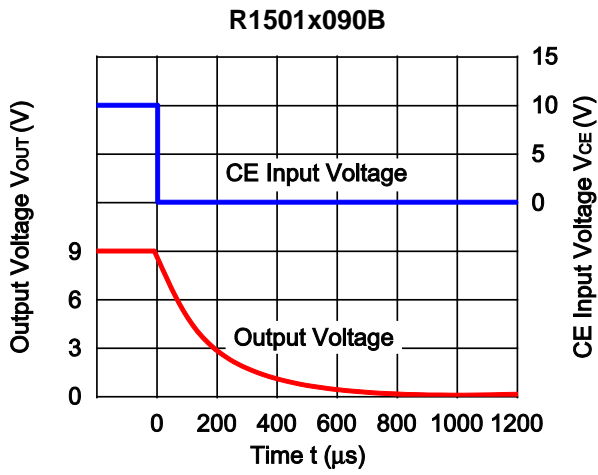
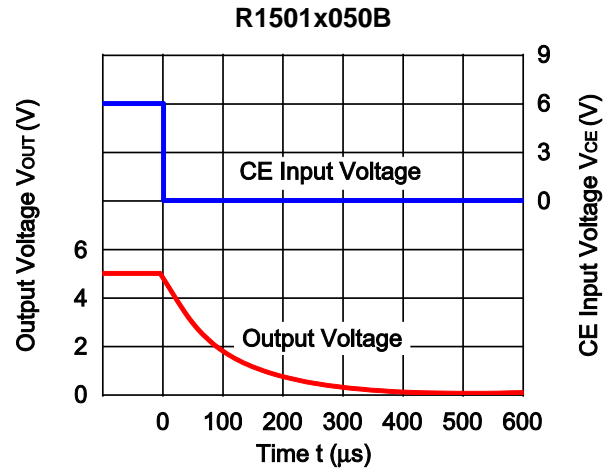
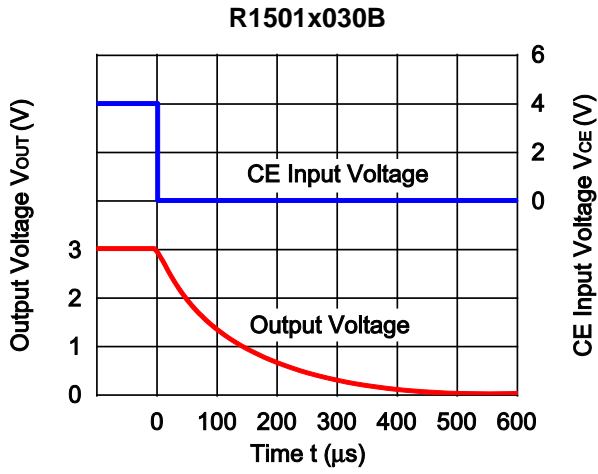


R1501x

NO.EA-184-160801



13) Turn Off Speed with CE (C1=Ceramic 0.47μF, C2=Ceramic 10μF, I_{OUT}=500mA, tr=tf=0.5μs)



R1501x

NO.EA-184-160801

ESR vs. Output Current

When using these ICs, consider the following points:

The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below.

The conditions when the white noise level is under the specified certain level are marked as the hatched area in the graph.

Measurement conditions

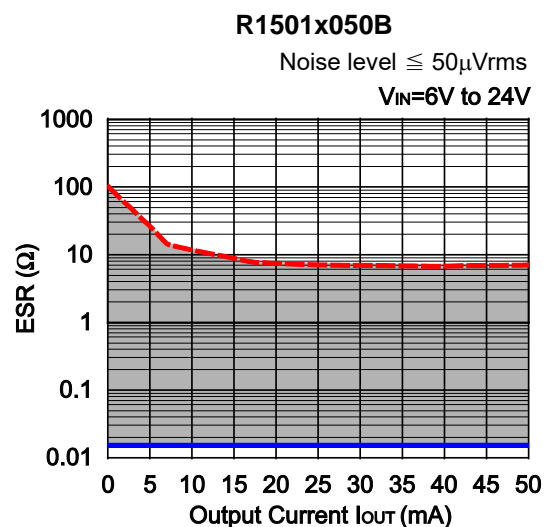
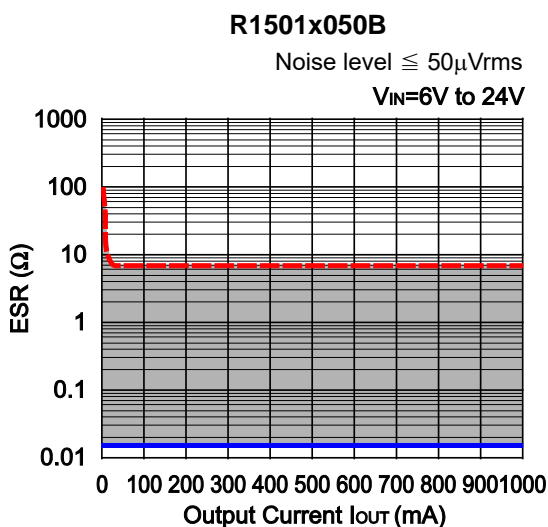
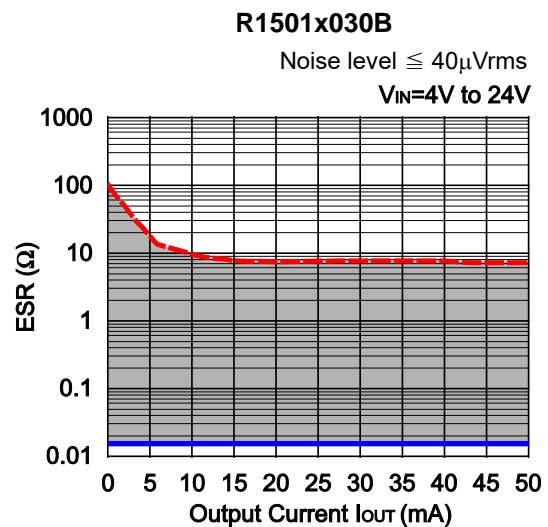
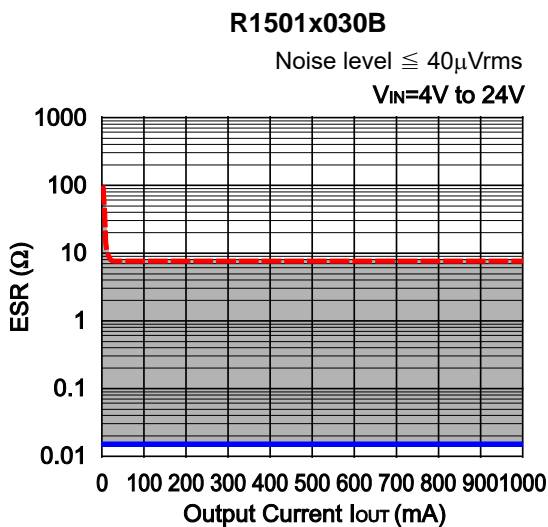
Input Voltage : $V_{OUT} + 1V$ to 24V

Frequency Band : 10Hz to 1MHz

Temperature : $-40^{\circ}C$ to $105^{\circ}C$

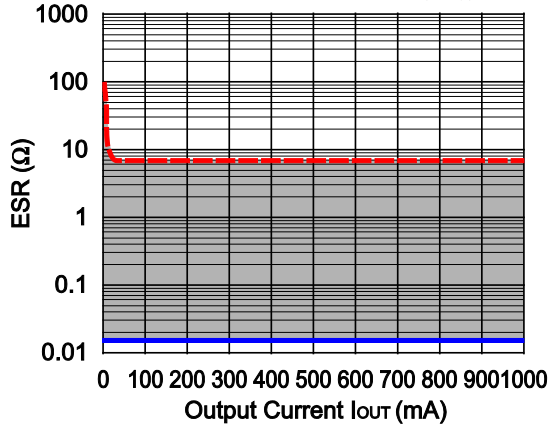
Capacitor : C1=Ceramic 0.47 μ F

C2=Ceramic 10 μ F



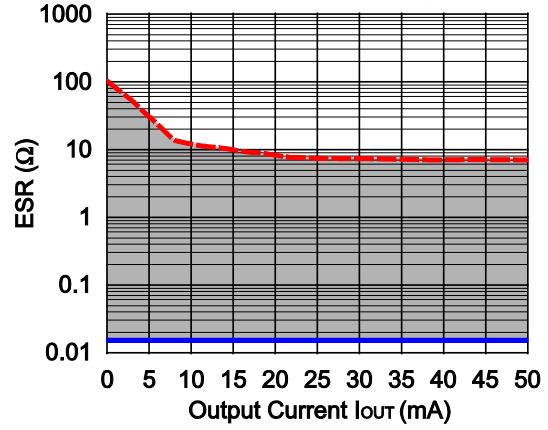
R1501x090B

Noise level $\leq 120\mu\text{Vrms}$
 $V_{\text{IN}}=10\text{V to }24\text{V}$



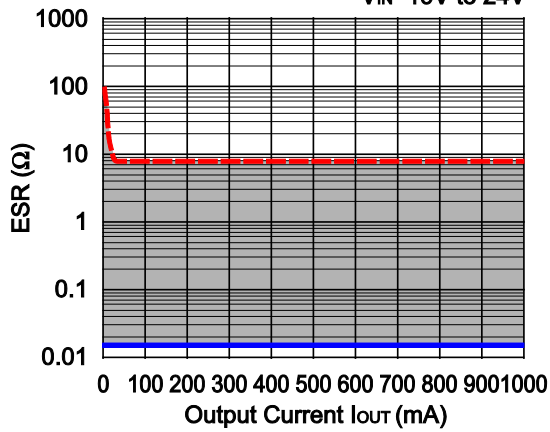
R1501x090B

Noise level $\leq 120\mu\text{Vrms}$
 $V_{\text{IN}}=10\text{V to }24\text{V}$



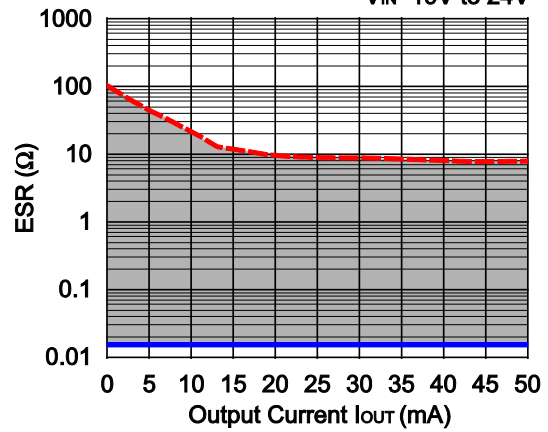
R1501x180B

Noise level $\leq 220\mu\text{Vrms}$
 $V_{\text{IN}}=19\text{V to }24\text{V}$



R1501x180B

Noise level $\leq 220\mu\text{Vrms}$
 $V_{\text{IN}}=19\text{V to }24\text{V}$



PACKAGE INFORMATION

Power Dissipation (TO-252-5-P2)

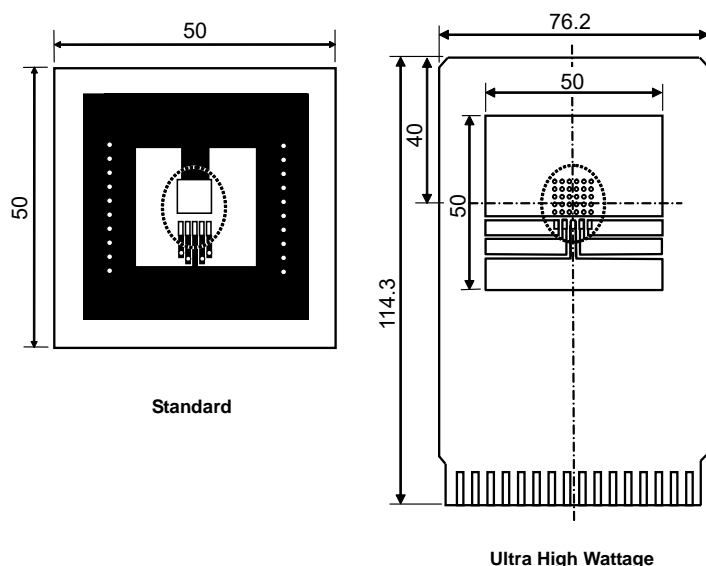
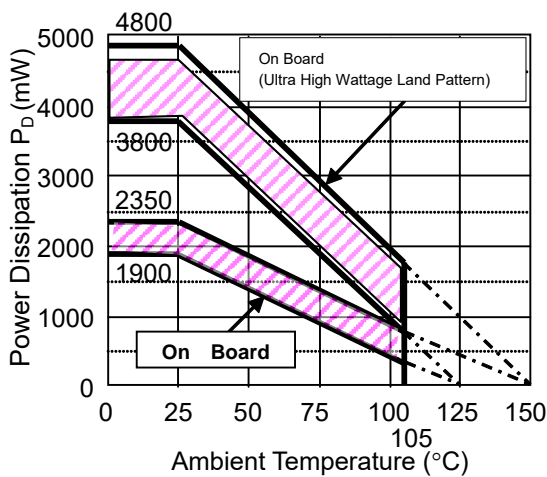
Power Dissipation (P_D) depends on conditions of mounting on board.
 This specification is based on the measurement at the condition below.

* Measurement conditions

	Standard Land Pattern	Ultra High Wattage Land Pattern
Environment	Mounting on board (Wind velocity 0m/s)	
Board Material	Glass cloth epoxy plastic (Double layers)	Glass cloth epoxy plastic (Four-layers)
Board Dimensions	50mm x 50mm x 1.6mm	76.2mm x 114.3mm x 0.8mm
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%	Top, Back side:50mmSquare Approx. 96%, 2nd, 3rd: 50mmSquare Approx. 100%
Through - hole	ϕ 0.5mm x 24pcs	ϕ 0.4mm x 30pcs

* Measurement Results (Ta=25°C, Tjmax=125°C)

	Standard Land Pattern	Ultra High Wattage Land Pattern
Power Dissipation	1900mW	3800mW
Thermal Resistance	$\theta_{ja}=(125-25^\circ\text{C})/1.9\text{W}= 53^\circ\text{C/W}$	$\theta_{ja}= (125-25^\circ\text{C})/3.8\text{W} = 26^\circ\text{C/W}$
	$\theta_{jc}= 17^\circ\text{C/W}$	$\theta_{jc}= 7^\circ\text{C/W}$

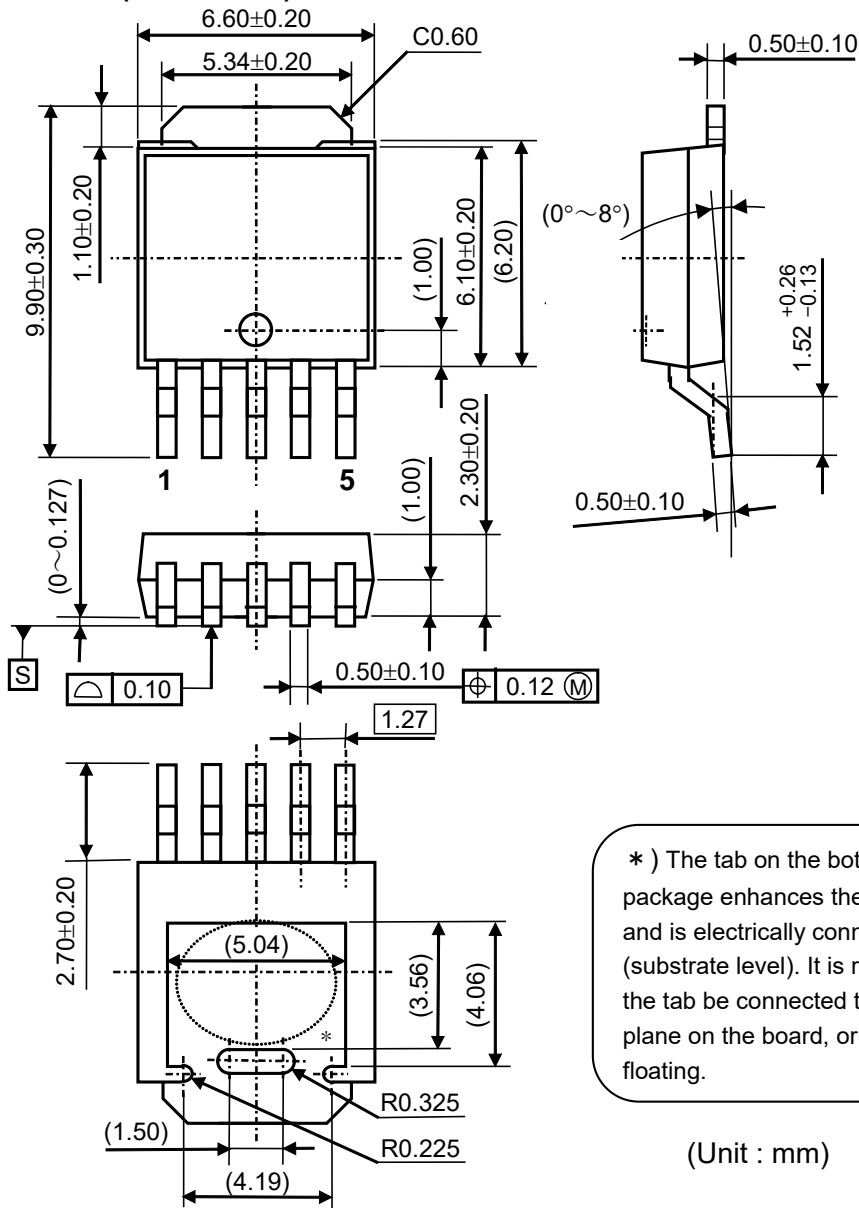


Measurement Board Pattern
 ○ IC Mount Area (Unit: mm)

The above graph shows the Power Dissipation of the package based on $T_{jmax}=125^\circ\text{C}$ and $T_{jmax}=150^\circ\text{C}$.
 Operating the IC in the shaded area in the graph might have an influence its lifetime. Operating time must be within the time limit described in the table below, in case of operating in the shaded area.

Operating Time	Estimated years (Operating four hours/day)
13,000 hours	9 years

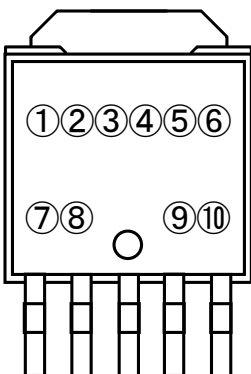
Package Dimensions (TO-252-5-P2)



*) The tab on the bottom of the package enhances thermal performance and is electrically connected to GND (substrate level). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left floating.

(Unit : mm)

Mark Specification (TO-252-5-P2)



① ② ③ ④ ⑤ ⑥ ⑦ : Product Code ... Refer to the R1501J Series Mark Specification Table.

⑧ : Blank

⑨ ⑩ : Lot Number ... Alphanumeric Serial Number

R1501J Series Mark Specification

(PKG: TO-252-5-P2)

Product Name	①	②	③	④	⑤	⑥	⑦	Product Name	①	②	③	④	⑤	⑥	⑦
R1501J030B	A	1	J	0	3	0	B	R1501J080B	A	1	J	0	8	0	B
R1501J031B	A	1	J	0	3	1	B	R1501J081B	A	1	J	0	8	1	B
R1501J032B	A	1	J	0	3	2	B	R1501J082B	A	1	J	0	8	2	B
R1501J033B	A	1	J	0	3	3	B	R1501J083B	A	1	J	0	8	3	B
R1501J034B	A	1	J	0	3	4	B	R1501J084B	A	1	J	0	8	4	B
R1501J035B	A	1	J	0	3	5	B	R1501J085B	A	1	J	0	8	5	B
R1501J036B	A	1	J	0	3	6	B	R1501J086B	A	1	J	0	8	6	B
R1501J037B	A	1	J	0	3	7	B	R1501J087B	A	1	J	0	8	7	B
R1501J038B	A	1	J	0	3	8	B	R1501J088B	A	1	J	0	8	8	B
R1501J039B	A	1	J	0	3	9	B	R1501J089B	A	1	J	0	8	9	B
R1501J040B	A	1	J	0	4	0	B	R1501J090B	A	1	J	0	9	0	B
R1501J041B	A	1	J	0	4	1	B	R1501J091B	A	1	J	0	9	1	B
R1501J042B	A	1	J	0	4	2	B	R1501J092B	A	1	J	0	9	2	B
R1501J043B	A	1	J	0	4	3	B	R1501J093B	A	1	J	0	9	3	B
R1501J044B	A	1	J	0	4	4	B	R1501J094B	A	1	J	0	9	4	B
R1501J045B	A	1	J	0	4	5	B	R1501J095B	A	1	J	0	9	5	B
R1501J046B	A	1	J	0	4	6	B	R1501J096B	A	1	J	0	9	6	B
R1501J047B	A	1	J	0	4	7	B	R1501J097B	A	1	J	0	9	7	B
R1501J048B	A	1	J	0	4	8	B	R1501J098B	A	1	J	0	9	8	B
R1501J049B	A	1	J	0	4	9	B	R1501J099B	A	1	J	0	9	9	B
R1501J050B	A	1	J	0	5	0	B	R1501J100B	A	1	J	1	0	0	B
R1501J051B	A	1	J	0	5	1	B	R1501J101B	A	1	J	1	0	1	B
R1501J052B	A	1	J	0	5	2	B	R1501J102B	A	1	J	1	0	2	B
R1501J053B	A	1	J	0	5	3	B	R1501J103B	A	1	J	1	0	3	B
R1501J054B	A	1	J	0	5	4	B	R1501J104B	A	1	J	1	0	4	B
R1501J055B	A	1	J	0	5	5	B	R1501J105B	A	1	J	1	0	5	B
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R1501J057B	A	1	J	0	5	7	B	R1501J107B	A	1	J	1	0	7	B
R1501J058B	A	1	J	0	5	8	B	R1501J108B	A	1	J	1	0	8	B
R1501J059B	A	1	J	0	5	9	B	R1501J109B	A	1	J	1	0	9	B
R1501J060B	A	1	J	0	6	0	B	R1501J110B	A	1	J	1	1	0	B
R1501J061B	A	1	J	0	6	1	B	R1501J111B	A	1	J	1	1	1	B
R1501J062B	A	1	J	0	6	2	B	R1501J112B	A	1	J	1	1	2	B
R1501J063B	A	1	J	0	6	3	B	R1501J113B	A	1	J	1	1	3	B
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R1501J066B	A	1	J	0	6	6	B	R1501J116B	A	1	J	1	1	6	B
R1501J067B	A	1	J	0	6	7	B	R1501J117B	A	1	J	1	1	7	B
R1501J068B	A	1	J	0	6	8	B	R1501J118B	A	1	J	1	1	8	B
R1501J069B	A	1	J	0	6	9	B	R1501J119B	A	1	J	1	1	9	B
R1501J070B	A	1	J	0	7	0	B	R1501J120B	A	1	J	1	2	0	B
R1501J071B	A	1	J	0	7	1	B	R1501J125B	A	1	J	1	2	5	B
R1501J072B	A	1	J	0	7	2	B	R1501J130B	A	1	J	1	3	0	B
R1501J073B	A	1	J	0	7	3	B	R1501J135B	A	1	J	1	3	5	B
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R1501J075B	A	1	J	0	7	5	B	R1501J145B	A	1	J	1	4	5	B
R1501J076B	A	1	J	0	7	6	B	R1501J150B	A	1	J	1	5	0	B
R1501J077B	A	1	J	0	7	7	B	R1501J155B	A	1	J	1	5	5	B
R1501J078B	A	1	J	0	7	8	B	R1501J160B	A	1	J	1	6	0	B
R1501J079B	A	1	J	0	7	9	B	R1501J165B	A	1	J	1	6	5	B
								R1501J170B	A	1	J	1	7	0	B
								R1501J175B	A	1	J	1	7	5	B
								R1501J180B	A	1	J	1	8	0	B

Power Dissipation (HSOP-6J)

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

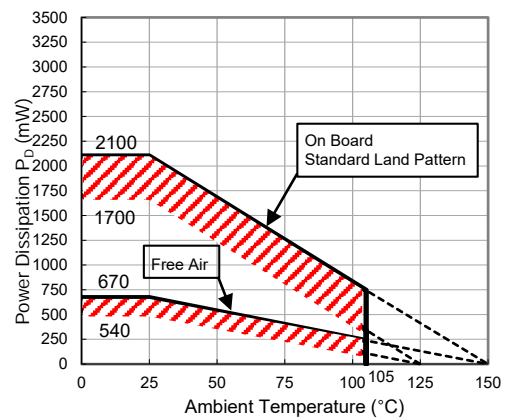
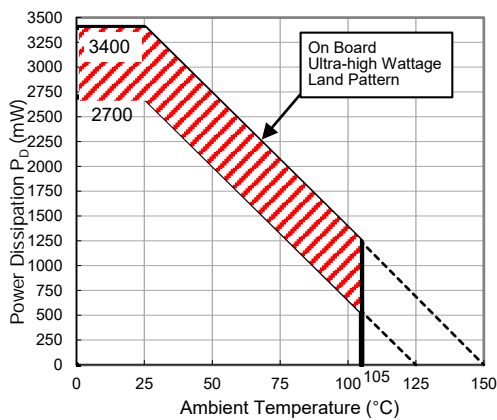
Measurement Conditions

	Ultra-high Wattage Land Pattern	Standard Land Pattern
Environment	Mounting on Board (Wind Velocity = 0 m/s)	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-layer Board)	Glass Cloth Epoxy Plastic (Double-sided Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm	50 mm × 50 mm × 1.6 mm
Copper Ratio	96%	50%
Through-holes	φ 0.3 mm × 28 pcs	φ 0.5 mm × 24 pcs

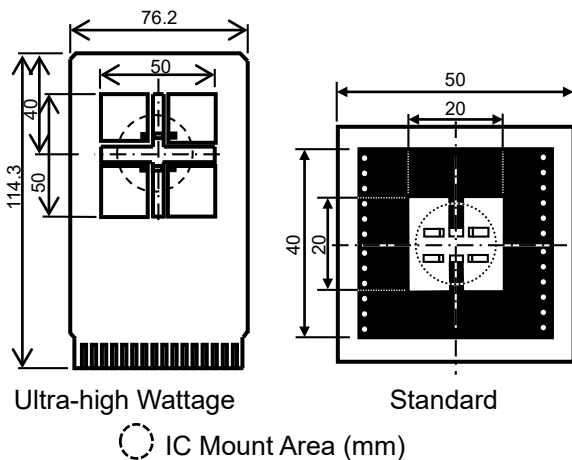
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

	Ultra-high Wattage Land Pattern	Standard Land Pattern	Free Air
Power Dissipation	2700 mW	1700 mW	540 mW
Thermal Resistance	37°C/W	59°C/W	185°C/W



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

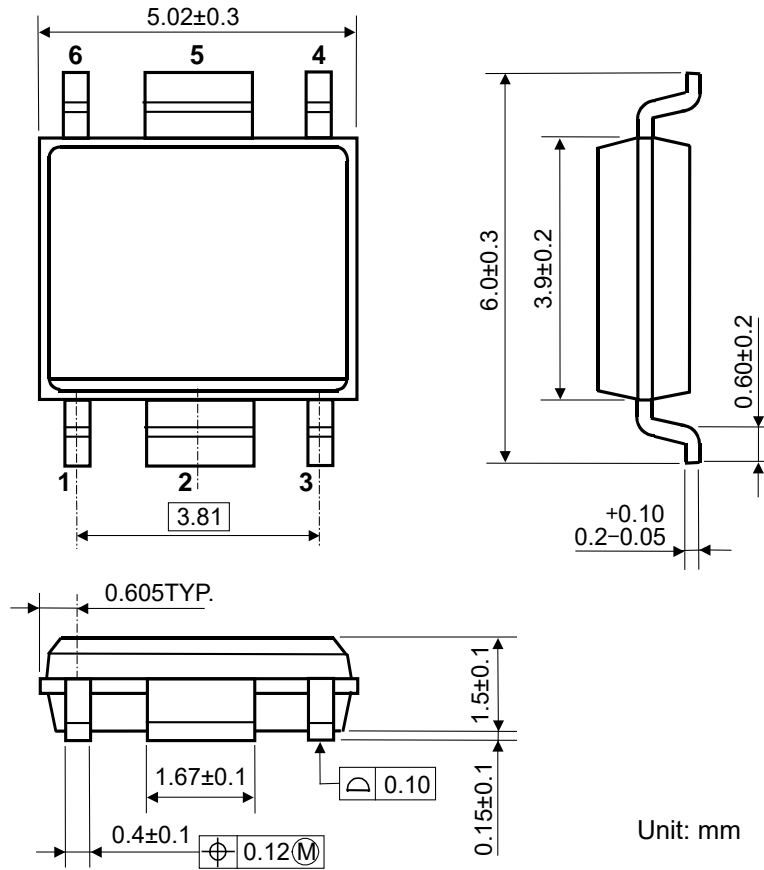
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

R1501x

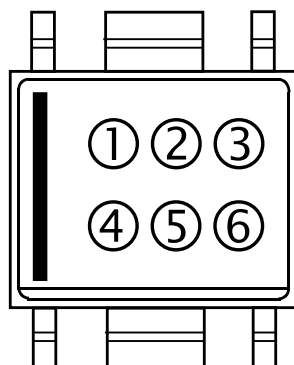
NO.EA-184-160801

Package Dimensions (HSOP-6J)



Mark Specification (HSOP-6J)

- ①②③④ : Product Code ... **Refer to the R1501S Series Mark Specification Table.**
⑤⑥ : Lot Number ... Alphanumeric Serial Number



R1501S Series Mark Specification

(PKG: HSOP-6J)

Product Name	①	②	③	④	Product Name	①	②	③	④
R1501S030B	H	0	3	0	R1501S080B	H	0	8	0
R1501S031B	H	0	3	1	R1501S081B	H	0	8	1
R1501S032B	H	0	3	2	R1501S082B	H	0	8	2
R1501S033B	H	0	3	3	R1501S083B	H	0	8	3
R1501S034B	H	0	3	4	R1501S084B	H	0	8	4
R1501S035B	H	0	3	5	R1501S085B	H	0	8	5
R1501S036B	H	0	3	6	R1501S086B	H	0	8	6
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R1501S043B	H	0	4	3	R1501S093B	H	0	9	3
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R1501S067B	H	0	6	7	R1501S117B	H	1	1	7
R1501S068B	H	0	6	8	R1501S118B	H	1	1	8
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R1501S075B	H	0	7	5	R1501S145B	H	1	4	5
R1501S076B	H	0	7	6	R1501S150B	H	1	5	0
R1501S077B	H	0	7	7	R1501S155B	H	1	5	5
R1501S078B	H	0	7	8	R1501S160B	H	1	6	0
R1501S079B	H	0	7	9	R1501S165B	H	1	6	5
					R1501S170B	H	1	7	0
					R1501S175B	H	1	7	5
					R1501S180B	H	1	8	0



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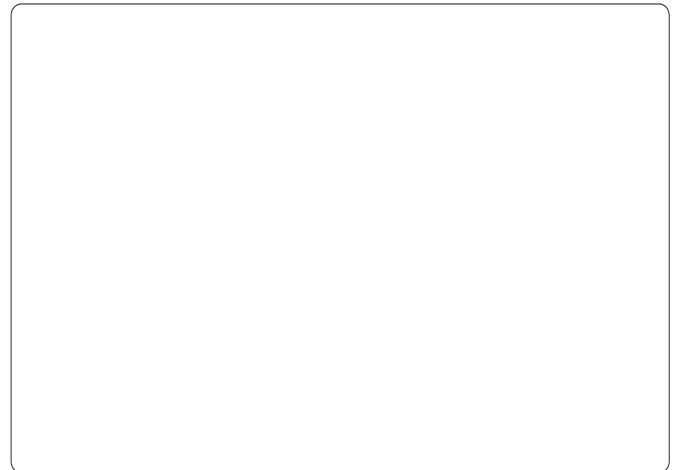
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